

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: [0743001157](#)
Status: **Active**
Overview: [HDM® Backplane Connector System](#)
Description: HDM® Board-to-Board Daughtercard Receptacle, Vertical, Signal Module, with Guide, 144 Circuits, Mounted Height 17.00mm, Solder tail Pin Length 3.50mm, Lead-Free

Documents:
[3D Model](#) [Product Specification PS-73780-999 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

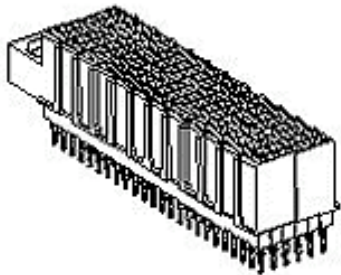
Agency Certification
UL

E29179

General
Product Family Backplane Connectors
Series [74300](#)
Application Daughtercard, Mezzanine
Component Type PCB Receptacle
Overview [HDM® Backplane Connector System](#)
Product Name HDM®
UPC 800756446936

Physical
Circuits (Loaded) 144
Circuits (maximum) 144
Color - Resin Black
Durability (mating cycles max) 250
First Mate / Last Break No
Flammability 94V-0
Guide to Mating Part Yes
Keying to Mating Part None
Material - Metal Copper-Nickel-Tin
Material - Plating Mating Gold
Material - Plating Termination Matte Tin
Material - Resin High Temperature Thermoplastic
Net Weight 20.520/g
Number of Columns 24
Number of Pairs Open Pin Field
Number of Rows 6
Orientation Vertical
PC Tail Length 3.50mm
PCB Locator No
PCB Retention None
PCB Thickness - Recommended 1.60mm
Packaging Type Tube
Pitch - Mating Interface 2.00mm
Pitch - Termination Interface 2.00mm
Plating min - Mating 0.762µm
Plating min - Termination 2.540µm
Polarized to PCB No
Stackable Yes
Surface Mount Compatible (SMC) Yes
Temperature Range - Operating -55°C to +105°C
Termination Interface: Style Solder or Weld

Electrical
Current - Maximum per Contact 1.0A



Series image - Reference only

EU ELV
Not Relevant

EU RoHS **China RoHS**
Compliant
REACH SVHC
Contains SVHC(2014 December 17): No
Halogen-Free
Status
Low-Halogen

Need more information on product environmental compliance?

Email productcompliance@molex.com
Please visit the [Contact Us](#) section for any non-product compliance questions.

China ROHS Green Image
ELV Not Relevant

Search Parts in this Series
[74300](#) Series

Mates With
HDM® Board-to-Board Backplane Header
[73642](#) , [73643](#) , [73644](#) , [74349](#) , [74428](#) ,
[73769](#) , [73781](#) , [73770](#) , [73782](#) , [73783](#) ,
[73771](#)

Data Rate	1.0 Gbps
Real Signals (per 25mm)	76
Shielded	Yes
Voltage - Maximum	250V AC
Solder Process Data	
Duration at Max. Process Temperature (seconds)	005
Lead-freeProcess Capability	WAVE
Max. Cycles at Max. Process Temperature	001
Process Temperature max. C	260
Material Info	
Reference - Drawing Numbers	
Product Specification	PS-73780-999
Sales Drawing	SD-74300-004
HDM and High Density Metric are trademarks of Amphenol Corporation	

This document was generated on 07/02/2015

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION